

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT4606909

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
TOSHIHIKO UTO	08/25/2017
TAKASHI SUEZAKI	08/25/2017
WATARU YOSHIDA	08/25/2017
RECEIVING PARTY DATA	
Name:	KANEKA CORPORATION
Street Address:	3-18, NAKANOSHIMA 2-CHOME, KITA-KU
City:	OSAKA-SHI, OSAKA
State/Country:	JAPAN
Postal Code:	5308288
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15560596
CORRESPONDENCE DATA	
Fax Number:	(703)518-5499
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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Email:	yshgroup@ipfirm.com
Correspondent Name:	HAUPTMAN HAM, LLP
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Address Line 2:	SUITE 1400
Address Line 4:	ALEXANDRIA, VIRGINIA 22314
ATTORNEY DOCKET NUMBER:	5820-0007
NAME OF SUBMITTER:	YOON S. HAM
SIGNATURE:	/Yoon S. Ham/
DATE SIGNED:	09/22/2017
Total Attachments: 3	
source=5820-0007_F_Assignment#page1.tif	
source=5820-0007_F_Assignment#page2.tif	
source=5820-0007_F_Assignment#page3.tif	

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

- | | |
|--------------------|---|
| 1) UTO, Toshihiko | 2) SUEZAKI, Takashi |
| 3) YOSHIDA, Wataru | 4) |
| 5) | <input type="checkbox"/> x box if continued on page 2 |

who has made a certain new and useful invention, hereby sells, assigns and transfers unto KANEKA CORPORATION having a place of business at 3-18, Nakanoshima 2-chome, Kita-ku, Osaka-shi, Osaka 5308288, Japan, its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled:

**METHOD FOR MANUFACTURING CRYSTALLINE SILICON SUBSTRATE FOR SOLAR CELL,
METHOD FOR MANUFACTURING CRYSTALLINE SILICON SOLAR CELL, AND METHOD
FOR MANUFACTURING CRYSTALLINE SILICON SOLAR CELL MODULE**

- (a) for which an application for United States Letters Patent was filed on _____, and identified by United States Patent Application No. _____; or
- (b) for which an application for United States Letters Patent was executed on _____.

and the undersigned hereby authorizes and requests the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefore and any and all extensions, divisions, reissues, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agrees that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agrees to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the date indicated aside my signature:

1) Toshihiko Uto
Name: UTO, Toshihiko

August 25, 2017

Date

2) _____
Name: SUEZAKI, Takashi

Date

3) _____
Name: YOSHIDA, Wataru

Date

4) _____
Name:

Date

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AND the undersigned hereby agrees to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the date indicated aside my signature:

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|---|----------------------------------|
| 1) _____
Name: UTO, Toshihiko | _____
Date |
| 2) <u>Takashi Suezaki</u>
Name: SUEZAKI, Takashi | August 25, 2017

Date |
| 3) _____
Name: YOSHIDA, Wataru | _____
Date |
| 4) _____
Name: | _____
Date |

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| 1) _____
Name: UTO, Toshihiko | _____
Date |
| 2) _____
Name: SUEZAKI, Takashi | _____
Date |
| 3) <u>Wataru Yoshida</u>
Name: YOSHIDA, Wataru | <u>August 25, 2017</u>
Date |
| 4) _____
Name: | _____
Date |